

<image>

# To learn more about ON Semiconductor, please visit our website at www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="https://www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to Fairchild guestions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and o vary in different applications and actual performance may vary over time. All operating parameters, including "Typical" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or una

January 2014



## FSB50550T Motion SPM<sup>®</sup> 5 Series

### Features

- UL Certified No. E209204 (UL1557)
- 500 V R<sub>DS(on)</sub> = 1.7 Ω(Max) FRFET MOSFET 3-Phase Inverter with Gate Drivers
- Separate Open-Source Pins from Low-Side MOSFETs for Three-Phase Current-Sensing
- Active-HIGH Interface, Works with 3.3 / 5 V Logic, Schmitt-trigger Input
- Optimized for Low Electromagnetic Interference
- HVIC for Gate Driving and Under-Voltage Protection
- Isolation Rating: 1500 V<sub>rms</sub> / min.
- RoHS Compliant

## Applications

 3-Phase Inverter Driver for Small Power AC Motor Drives

## **Related Source**

- <u>AN-9082 Motion SPM5 Series Thermal Performance</u> <u>by Contact Pressure</u>
- AN-9080 User's Guide for Motion SPM 5 Series Ver.1

### **General Description**

The FSB50550T is an advanced Motion SPM<sup>®</sup> 5 module providing a fully-featured, high-performance inverter output stage for AC Induction, BLDC and PMSM motors. These modules integrate optimized gate drive of the built-in MOSFETs (FRFET<sup>®</sup> technology) to minimize EMI and losses. The built-in, high-speed HVIC requires only a single supply voltage and translates the incoming logic-level gate inputs to the high-voltage, high-current drive signals required to properly drive the module's internal MOSFETs. Separate open-source MOSFET terminals are available for each phase to support the widest variety of control algorithms.



### **Package Marking & Ordering Information**

Device	Device Marking	Package	Packing Type	Quantity
FSB50550T	FSB50550T	SPM5F-023	Rail	15

©2007 Fairchild Semiconductor Corporation FSB50550T Rev. C4

## **Absolute Maximum Ratings**

Inverter Part (each MOSFET unless otherwise specified.)

Symbol	Parameter	Conditions	Rating	Unit
V <sub>DSS</sub>	Drain-Source Voltage of Each MOSFET		500	V
*I <sub>D 25</sub>	Each MOSFET Drain Current, Continuous	$T_{C} = 25^{\circ}C$	1.8	A
*I <sub>D 80</sub>	Each MOSFET Drain Current, Continuous	$T_{C} = 80^{\circ}C$	1.2	A
*I <sub>DP</sub>	Each MOSFET Drain Current, Peak	T <sub>C</sub> = 25°C, PW < 100 μs	3.5	A
*P <sub>D</sub>	Maximum Power Dissipation	$T_{C} = 25^{\circ}C$ , For Each MOSFET	4.5	W

**Control Part** (each HVIC unless otherwise specified.)

Symbol	Parameter	Conditions	Rating	Unit
V <sub>CC</sub>	Control Supply Voltage	Applied Between V <sub>CC</sub> and COM	20	V
V <sub>BS</sub>	High-side Bias Voltage	Applied Between $V_B$ and $V_S$	20	V
V <sub>IN</sub>	Input Signal Voltage	Applied Between IN and COM	-0.3 ~ V <sub>CC</sub> + 0.3	V

### Thermal Resistance

Symbol	Parameter	Conditions	Rating	Unit
$R_{ extsf{ heta}JC}$	Junction to Case Thermal Resistance	Each MOSFET under Inverter Oper- ating Condition (1st Note 1)	8.6	°C/W

### **Total System**

olai Sysle				
Symbol	Parameter	Conditions	Rating	Unit
TJ	Operating Junction Temperature		-20 ~ 150	°C
T <sub>STG</sub>	Storage Temperature		-50 ~ 150	°C
V <sub>ISO</sub>	Isolation Voltage	60 Hz, Sinusoidal, 1 Minute, Con- nect Pins to Heat Sink Plate	1500	V <sub>rms</sub>

### 1st Notes:

1. For the measurement point of case temperature  $\mathsf{T}_\mathsf{C},$  please refer to Figure 4.

2. Marking "\*" is calculation value or design factor.

©2007 Fairchild Semiconductor Corporation FSB50550T Rev. C4

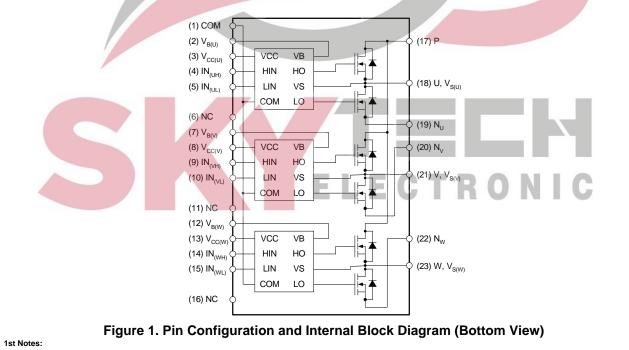
2

ELECTRO

FSB505501
Motion
SPM® 5 Series

## **Pin descriptions**

Pin Number	Pin Name	Pin Description	
1	COM	IC Common Supply Ground	
2	V <sub>B(U)</sub>	Bias Voltage for U Phase High Side MOSFET <sup>®</sup> Driving	
3	V <sub>CC(U)</sub>	ias Voltage for U Phase IC and Low Side MOSFET Driving	
4	IN <sub>(UH)</sub>	Signal Input for U Phase High-Side	
5	IN <sub>(UL)</sub>	Signal Input for U Phase Low-Side	
6	N.C	No Connectiion	
7	V <sub>B(V)</sub>	Bias Voltage for V Phase High Side MOSFET Driving	
8	V <sub>CC(V)</sub>	Bias Voltage for V Phase IC and Low Side MOSFET Driving	
9	IN <sub>(VH)</sub>	Signal Input for V Phase High-Side	
10	IN <sub>(VL)</sub>	Signal Input for V Phase Low-Side	
11	N.C	No Connectiion	
12	V <sub>B(W)</sub>	Bias Voltage for W Phase High Side MOSFET Driving	
13	V <sub>CC(W)</sub>	Bias Voltage for W Phase IC and Low Side MOSFET Driving	
14	IN <sub>(WH)</sub>	Signal Input for W Phase High-Side	
15	IN <sub>(WL)</sub>	Sig <mark>nal Input fo</mark> r W Phase Low-Side	
16	N.C	No Connectiion	
17	Р	Positive DC-Link Input	
18	U, V <sub>S(U)</sub>	Output for U Phase & Bias Voltage Ground for High Side MOSFET Driving	
19	NU	Negative DC-Link Input for U Phase	
20	N <sub>V</sub>	Negative DC-Link Input for V Phase	
21	V, V <sub>S(V)</sub>	Output for V Phase & Bias Voltage Ground for High Side MOSFET Driving	
22	N <sub>W</sub>	Negative DC-Link Input for W Phase	
23	W, V <sub>S(W)</sub>	Output for W Phase & Bias Voltage Ground for High Side MOSFET Driving	



3. Source terminal of each low-side MOSFET is not connected to supply ground or bias voltage ground inside Motion SPM<sup>®</sup> 5 product. External connections should be made as indicated in Figure 3.

©2007 Fairchild Semiconductor Corporation FSB50550T Rev. C4

## **Electrical Characteristics** ( $T_J = 25^{\circ}C$ , $V_{CC} = V_{BS} = 15$ V unless otherwise specified.)

**Inverter Part** (each MOSFET unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
BV <sub>DSS</sub>	Drain - Source Breakdown Voltage	V <sub>IN</sub> = 0 V, I <sub>D</sub> = 250 μA (2nd Note 1)	500	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>IN</sub> = 0 V, V <sub>DS</sub> = 500V	-	-	250	μΑ
R <sub>DS(on)</sub>	Static Drain - Source Turn-On Resistance	V <sub>CC</sub> = V <sub>BS</sub> = 15 V, V <sub>IN</sub> = 5 V, I <sub>D</sub> = 1.2 A	-	1.3	1.7	Ω
V <sub>SD</sub>	Drain - Source Diode Forward Voltage	$V_{CC} = V_{BS} = 15V, V_{IN} = 0 V, I_D = -1.2 A$	-	-	1.2	V
t <sub>ON</sub>			-	560	-	ns
t <sub>OFF</sub>		$V_{PN} = 300 \text{ V}, V_{CC} = V_{BS} = 15 \text{ V}, I_D = 1.2 \text{ A}$	-	440	-	ns
t <sub>rr</sub>	Switching Times	$V_{IN} = 0 V \leftrightarrow 5 V$ , Inductive Load L = 3 mH High- and Low-Side MOSFET Switching	-	130	-	ns
E <sub>ON</sub>		(2nd Note 2)	-	71	-	μJ
E <sub>OFF</sub>			-	11	-	μJ
RBSOA	Reverse Bias Safe Oper- ating Area	$V_{PN} = 400 \text{ V}, \text{ V}_{CC} = \text{V}_{BS} = 15 \text{ V}, \text{ I}_{D} = \text{I}_{DP}, \text{ V}_{DS} = \text{BV}_{DSS},$ T <sub>J</sub> = 150°C High- and Low-Side MOSFET Switching (2nd Note 3)		Full	Square	

### Control Part (each HVIC unless otherwise specified.)

		,					
Symbol	Parameter		Conditions	Min	Тур	Max	Unit
IQCC	Quiescent V <sub>CC</sub> Current	V <sub>CC</sub> = 15 V, V <sub>IN</sub> = 0 V	Applied Between V <sub>CC</sub> and COM	-	-	160	μA
I <sub>QBS</sub>	Quiescent V <sub>BS</sub> Current	V <sub>BS</sub> = 15 V, V <sub>IN</sub> = 0 V	$\begin{array}{l} \mbox{Applied Between V}_{B(U)} \mbox{-} U, \\ \mbox{V}_{B(V)} \mbox{-} V, \mbox{V}_{B(W)} \mbox{-} W \end{array}$	-	-	100	μA
UV <sub>CCD</sub>	Low-Side Under-Voltage	V <sub>CC</sub> Under-Voltage	Protection Detection Level	7.4	8.0	9.4	V
UV <sub>CCR</sub>	Protection (Figure 8)	V <sub>CC</sub> Under-Voltage	Protection Reset Level	8.0	8.9	9.8	V
UV <sub>BSD</sub>	High-Side Under-Voltage	V <sub>BS</sub> Under-Voltage	Protection Detection Level	7.4	8.0	9.4	V
UV <sub>BSR</sub>	Protection (Figure 9)	V <sub>BS</sub> Under-Voltage	Protection Reset Level	8.0	8.9	9.8	V
V <sub>IH</sub>	ON Threshold Voltage	Logic HIGH Level	Applied between IN and COM	2.9	-	-	V
V <sub>IL</sub>	OFF Threshold Voltage	Logic LOW Level	Applied between IN and COM	-	-	0.8	V
I <sub>IH</sub>	Input Pice Current	V <sub>IN</sub> = 5 V	Applied between IN and COM	-	10	20	μΑ
IL	Input Bias Current	$V_{IN} = 0 V$	Applied between IN and COM	-	-	2	μA

2nd Notes:

1. BV<sub>DSS</sub> is the absolute maximum voltage rating between drain and source terminal of each MOSFET inside Motion SPM<sup>®</sup> 5 product. V<sub>PN</sub> should be sufficiently less than this value considering the effect of the stray inductance so that V<sub>PN</sub> should not exceed BV<sub>DSS</sub> in any case.

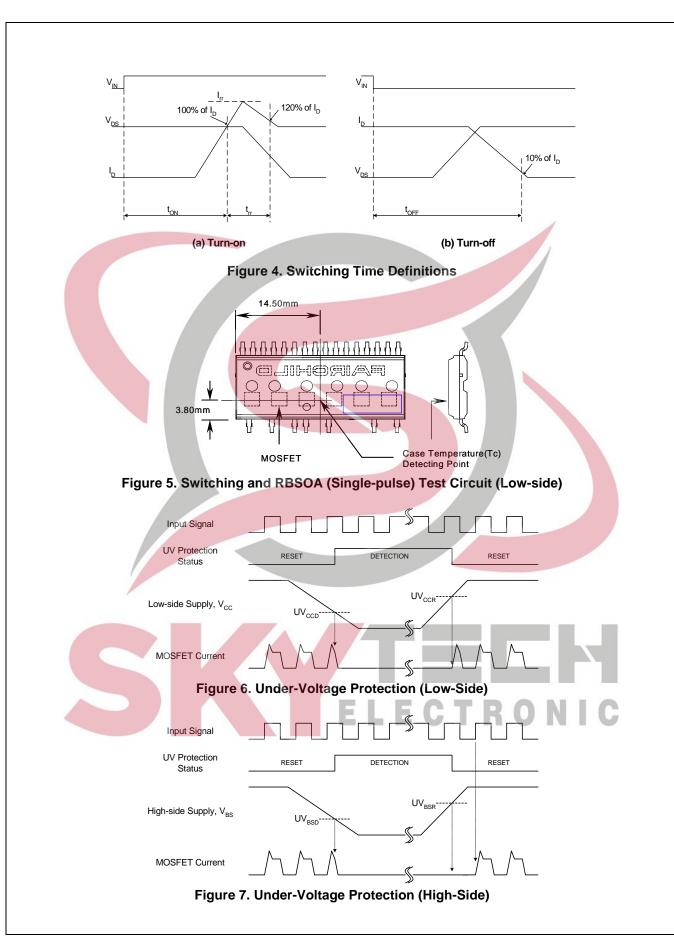
2. t<sub>ON</sub> and t<sub>OFF</sub> include the propagation delay of the internal drive IC. Listed values are measured at the laboratory test condition, and they can be different according to the field applications due to the effect of different printed circuit boards and wirings. Please see Figure 4 for the switching time definition with the switching test circuit of Figure 5.

3. The peak current and voltage of each MOSFET during the switching operation should be included in the Safe Operating Area (SOA). Please see Figure 5 for the RBSOA test circuit that is same as the switching test circuit.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V <sub>PN</sub>	Supply Voltage	Applied Between P and N	-	300	400	V
V <sub>CC</sub>	Control Supply Voltage	Applied Between $V_{CC}$ and COM	13.5	15.0	16.5	V
V <sub>BS</sub>	High-Side Bias Voltage	Applied Between $V_B$ and $V_S$	13.5	15.0	16.5	V
V <sub>IN(ON)</sub>	Input ON Threshold Voltage		3.0	-	V <sub>CC</sub>	V
V <sub>IN(OFF)</sub>	Input OFF Threshold Voltage	Applied Between IN and COM	0	-	0.6	V
t <sub>dead</sub>	Blanking Time for Preventing Arm-Short	$V_{CC} = V_{BS} = 13.5 \sim 16.5 \text{ V}, \text{ T}_{J} \le 150^{\circ}\text{C}$	1.0	-	-	μS
f <sub>PWM</sub>	PWM Switching Frequency	T <sub>J</sub> ≤ 150°C	-	15	-	kHz
т <sub>с</sub>	Case Temperature	T <sub>J</sub> ≤ 150°C	-20	- ,	125	°C
Micom		VB Inverter Output	HIN LIN 0 0 0 1	Output Z	Not Both FRF Low side F	ET Off
			1 0	VDC	High side F	
			1 1	Forbidden	Shoot th	nrough
	│ ┌─┤ ↓ ↓ <del>▼</del> │ <b>└</b> ───		<mark>Op</mark> en Open	Z	Same as	s (0,0)
'		bootstrap paramters: μF ceramic capacitor,				
rd Notes: It is recomm Parameters RC-coupling Bold lines st	• Example of $C_1 = C_2 = 1$ $R_1 = 56\Omega_2$ Figure 2. Recomme wended the bootstrap diode D <sub>1</sub> to have soft for bootstrap circuit elements are depended $(R_5 \text{ and } C_5)$ and $C_4$ at each input of Motion hould be short and thick in PCB pattern to b and have good high-frequency characteristic	μF ceramic capacitor, <b>Inded MCU Interface and Bootstrag</b> and fast recovery characteristics with 600 V Rating. Int on PWM algorithm. For 15 kHz of switching frequency, typ on SPM 5 product and MCU (Indicated as Dotted Lines) may have small stray inductance of circuit, which results in the red	bical example of piece used to preven	parameters is sent improper si	shown above.	urge-noise.

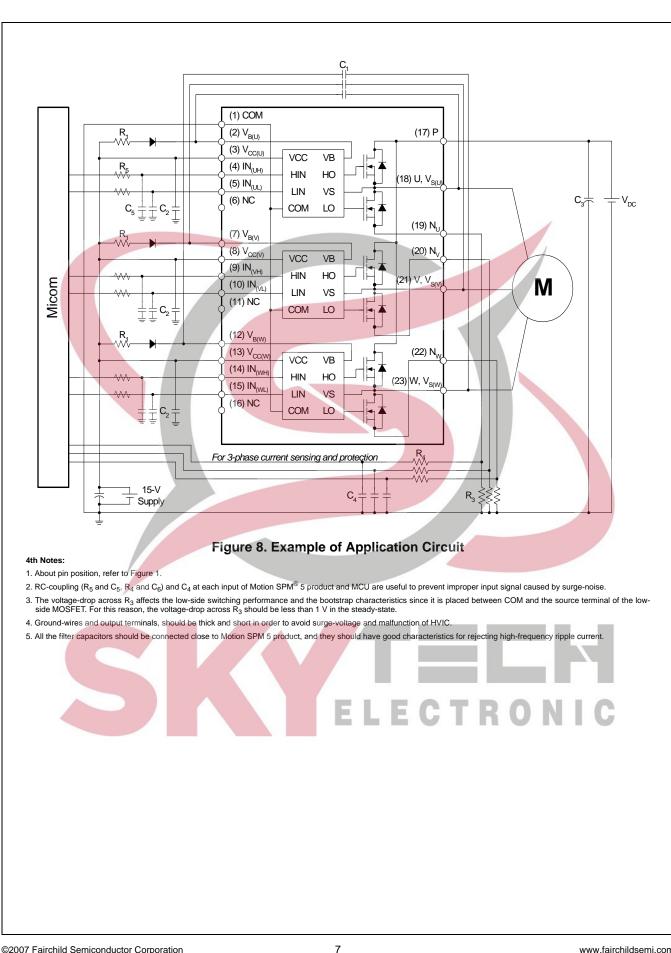
©2007 Fairchild Semiconductor Corporation FSB50550T Rev. C4

FSB50550T Motion SPM® 5 Series

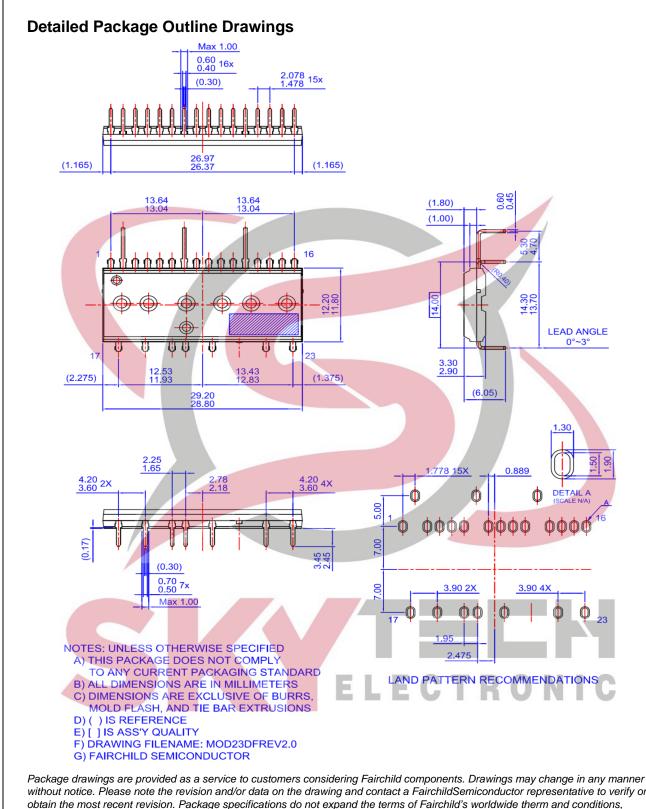


©2007 Fairchild Semiconductor Corporation FSB50550T Rev. C4 www.fairchildsemi.com





©2007 Fairchild Semiconductor Corporation FSB50550T Rev. C4



without notice. Please note the revision and/or data on the drawing and contact a FairchildSemiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide therm and conditions, specifically the the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

http://www.fairchildsemi.com/dwg/MO/MOD23DF.pdf

published by WWW.SKYTECH.IR

©2007 Fairchild Semiconductor Corporation FSB50550T Rev. C4

FSB50550T Motion SPM® 5 Series



#### TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™	F-PFS™		Sync-Lock™
AX-CAP®*	FRFET®	۲	SYSTEM GENERAL®
BitSiC™	Global Power Resource <sup>SM</sup>	PowerTrench®	GENERAL
Build it Now™	GreenBridge™	PowerXS™	TinyBoost®
CorePLUS™	Green FPS™	Programmable Active Droop™	TinyBuck®
CorePOWER™	Green FPS™ e-Series™	QFET <sup>®</sup>	TinyCalc™
ROSSVOLT	Gmax™	QSTM	TinyLogic®
TLTM	GTO™	Quiet Series™	TINYOPTOM
urrent Transfer Logic <sup>™</sup>	IntelliMAX <sup>™</sup>	RapidConfigure™	TinyPower™
DEUXPEED	ISOPLANAR	Taplacolingure	TinyPWM™
Dual Cool™	Making Small Speakers Sound Louder	0	TinyWire™
COSPARK®	and Better™	Saving our world, 1mW/W/kW at a time™	TranSiC™
EfficientMax™	MegaBuck™	SignalWise™	TriFault Detect™
SBCTM	MICROCOUPLER	SmartMax™	TRUECURRENT®*
<b>~</b> ®	MicroFET™	SMART START	µSerDes™
<b>r</b>	MicroPak™	Solutions for Your Success™	
airchild®	MicroPak2 <sup>TM</sup>	SPM®	SerDes
airchild Semiconductor®	MillerDrive™	STEALTH	UHC®
ACT Quiet Series™	MotionMax <sup>™</sup>	SuperFET®	Ultra FRFET™
ACT	mWSaver®	SuperSOT™-3	UniFET™
AST®	OptoHiT™	SuperSOT™-6	VCXTM
fastvCore™	OPTOLOGIC®	SuperSOT™-8	VisualMax™
ETBench™	OPTOPLANAR®	SupreMOS®	
PS™		SyncFET <sup>TM</sup>	VoltagePlus™ XS™

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS, THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

### As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild warranties or other assistance for parts bought from Unauthorized Sources. Fairchild to combat this global problem and encourage our customers to obter the page by bying direct or from authorized distributors.

#### **PRODUCT STATUS DEFINITIONS**

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 166

©2007 Fairchild Semiconductor Corporation FSB50550T Rev. C4



ON Semiconductor and ware trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdi/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor haves, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such uninte

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada Fax: 303–675–2176 or 800–344–3867 Toll Free USA/Canada Email: orderlit@onsemi.com

© Semiconductor Components Industries, LLC

N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

www.onsemi.com

## **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

